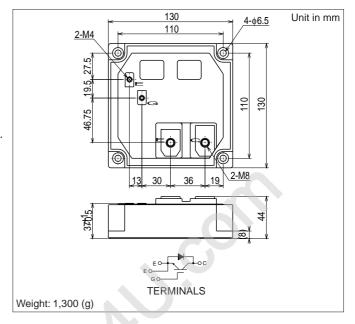
MBN1200GS12AW

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High speed and low saturation voltage.
- * low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- * Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Item		Symbol	Unit	MBN1200GS12AW		
Collector Emitter Voltage		Vces	V	1,200		
Gate Emitter Voltage		V_{GES}	V	±20		
Collector Current	DC	Ic	А	1,200		
	1ms	I _{Cp}	A	2,400		
Forward Current	DC	IF	А	1,200 (1)		
	1ms	I _{FM}	A	2,400		
Collector Power Dissipation		Pc	W	5,600		
Junction Temperature		Tj	°C	-40 ~ +150		
Storage Temperature		T_{stg}	°C	-40 ~ +125		
Isolation Voltage		V _{ISO}	V_{RMS}	2,500(AC 1 minute)		
Screw Torque Terr	ninals	(0):	N.m	1.37(14)/7.84(80) (2)		
Mou	nting	-	(kgf.cm)	2.94(30) (3)		

Notes:(1)RMS Current of Diode 360Arms max.

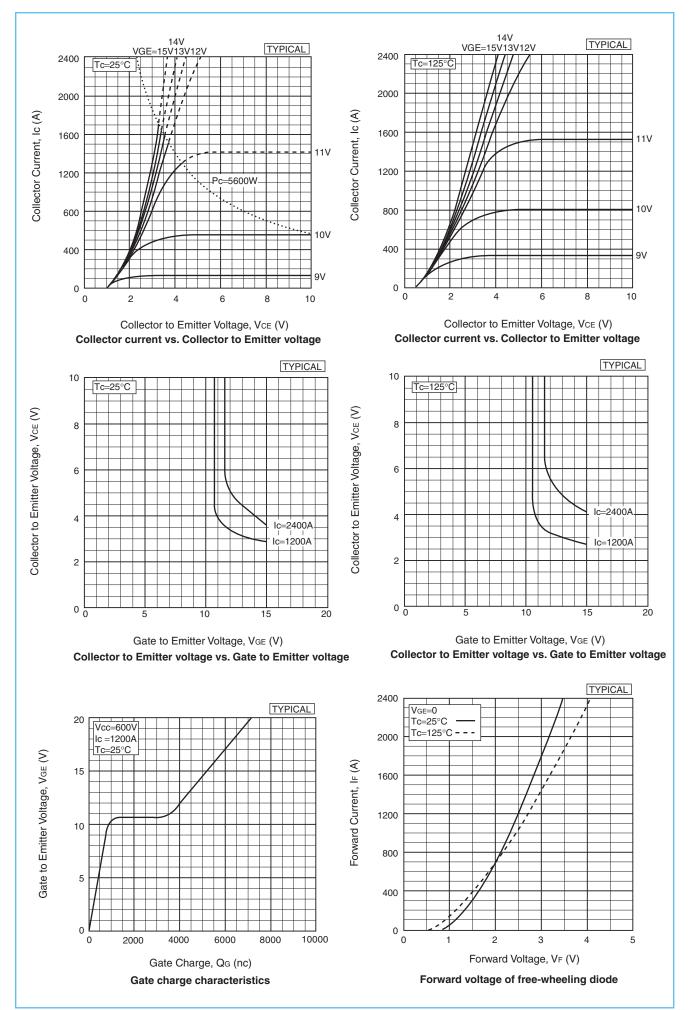
(2) Recommended Value 1.18/7.35N.m(12/75kgf.cm)

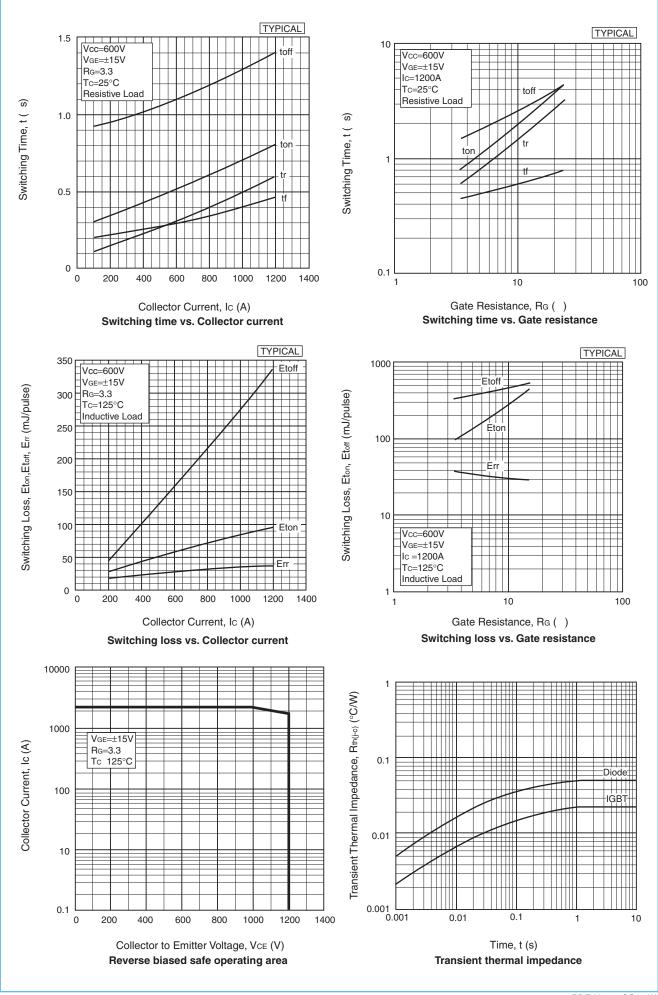
(3) Recommended Value 2.45 N.m(25kgf.cm)

CHARACTERISTICS (Tc=25°C)

Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	2.0	V _{CE} =1,200V,V _{GE} =0V
Gate Emitter Leakage Current		I _{GES}	nA	-	-	±500	V _{GE} =±20V,V _{CE} =0V
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	2.9	3.6	I _C =1,200A,V _{GE} =15V
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	-	-	10	V _{CE} =5V, I _C =1,200mA
Input Capacitance		Cies	nF	-	112	-	V _{CE} =10V,V _{GE} =0V,f=1MHz
	Rise Time	tr		-	0.6	1.6	Vcc=600V
Switching Times	Turn On Time	ton	μS	-	0.8	2.2	R _L =0.5Ω
o e	Fall Time	t _f		-	0.45	0.55	$R_G=3.3\Omega$ (4)
	Turn Off Time	t _{off}		-	1.4	1.6	V _{GE} =±15V
Peak Forward Voltage Drop		V _{FM}	V	-	2.5	3.7	I _F =1,200A,V _{GE} =0V
Reverse Recovery Time		trr	μS	-	-	0.5	I _F =1,200A,V _{GE} =-10V, di/dt=1200A/μS
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.022	Junction to case
	FWD	Rth(j-c)		-	-	0.05	

Notes:(4) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.





HITACHI POWER SEMICONDUCTORS

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